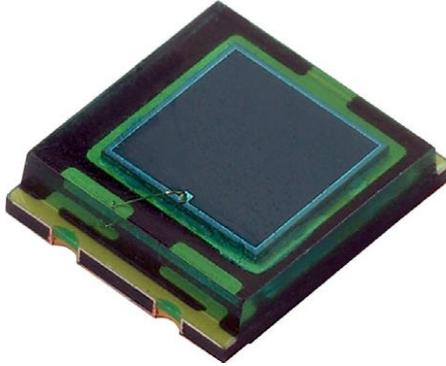


## Ambient Light Sensor



### DESCRIPTION

TEMD5510FX01 ambient light sensor is a PIN photodiode with high photo sensitivity in a miniature surface mount device (SMD). The detector chip has 7.5 mm<sup>2</sup> sensitive area. It is sensitive to visible light much like the human eye and has peak sensitivity at 540 nm.

### FEATURES

- Package type: surface-mount
- Package form: top view
- Dimensions (L x W x H in mm): 5 x 4.24 x 1.12
- Radiant sensitive area (in mm<sup>2</sup>): 7.5
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Supression filter for near infrared radiation
- Angle of half sensitivity:  $\varphi = \pm 65^\circ$
- Floor life: 72 h, MSL 4, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- Automotive sensors
- Ambient light sensors
- Backlight dimmers
- Notebooks
- Computers

### PRODUCT SUMMARY

| COMPONENT    | $I_{ra}$ ( $\mu A$ ) | $\varphi$ ( $^\circ$ ) | $\lambda_{0.5}$ (nm) |
|--------------|----------------------|------------------------|----------------------|
| TEMD5510FX01 | 1                    | $\pm 65$               | 430 to 610           |

#### Note

- Test conditions see table “Basic Characteristics”

### ORDERING INFORMATION

| ORDERING CODE     | PACKAGING     | REMARKS                      | PACKAGE FORM |
|-------------------|---------------|------------------------------|--------------|
| TEMD5510FX01      | Tape and reel | MOQ: 1500 pcs, 1500 pcs/reel | Top view     |
| TEMD5510FX01-GS15 | Tape and reel | MOQ: 5000 pcs, 5000 pcs/reel | Top view     |

#### Note

- MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ C$ , unless otherwise specified)

| PARAMETER                              | TEST CONDITION                            | SYMBOL     | VALUE       | UNIT       |
|--|---|------------|-------------|------------|
| Reverse voltage                        |   | $V_R$      | 16          | V          |
| Power dissipation                      | $T_{amb} \leq 25^\circ C$                 | $P_V$      | 215         | mW         |
| Junction temperature                   |   | $T_j$      | 100         | $^\circ C$ |
| Operating temperature range            |   | $T_{amb}$  | -40 to +100 | $^\circ C$ |
| Storage temperature range              |   | $T_{stg}$  | -40 to +110 | $^\circ C$ |
| Soldering temperature                  | According to reflow solder profile Fig. 5 | $T_{sd}$   | 260         | $^\circ C$ |
| Thermal resistance junction-to-ambient | JESD51                                    | $R_{thJA}$ | 350         | K/W        |

| <b>BASIC CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |   |                 |      |            |      |               |
|---|---|-----------------|------|------------|------|---------------|
| PARAMETER   | TEST CONDITION  | SYMBOL          | MIN. | TYP.       | MAX. | UNIT          |
| Breakdown voltage   | $I_R = 100\text{ }\mu\text{A}$ , $E = 0$                                  | $V_{(BR)}$      | 16   | -          | -    | V             |
| Reverse dark current  | $V_R = 10\text{ V}$ , $E = 0$   | $I_{ro}$        | -    | 2          | 30   | nA            |
| Diode capacitance   | $V_R = 0\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0$                         | $C_D$           | -    | 1600       | -    | pF            |
|   | $V_R = 3\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0$                         | $C_D$           | -    | 730        | -    | pF            |
| Reverse light current   | $E_e = 1\text{ mW/cm}^2$ , $\lambda = 550\text{ nm}$ , $V_R = 5\text{ V}$ | $I_{ra}$        | -    | 26         | -    | $\mu\text{A}$ |
|   | $E_v = 100\text{ lx}$ , CIE illuminant A, $V_R = 5\text{ V}$              | $I_{ra}$        | 0.8  | 1          | 1.4  | $\mu\text{A}$ |
| Temperature coefficient of $I_{ra}$   | $E_v = 100\text{ lx}$ , CIE illuminant A, $V_R = 5\text{ V}$              | $TK_{I_{ra}}$   | -    | 0.2        | -    | %/K           |
| Angle of half sensitivity   |   | $\phi$          | -    | $\pm 65$   | -    | $^{\circ}$    |
| Wavelength of peak sensitivity  |   | $\lambda_p$     | -    | 540        | -    | nm            |
| Range of spectral bandwidth   |   | $\lambda_{0.5}$ | -    | 430 to 610 | -    | nm            |

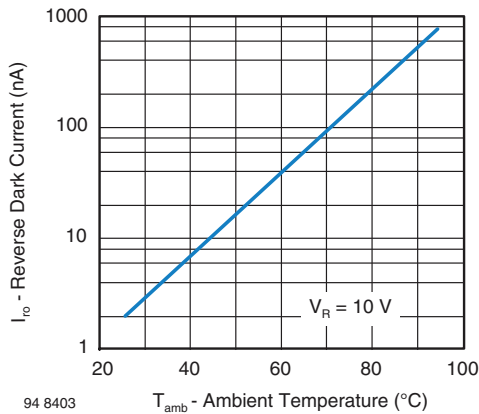
**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

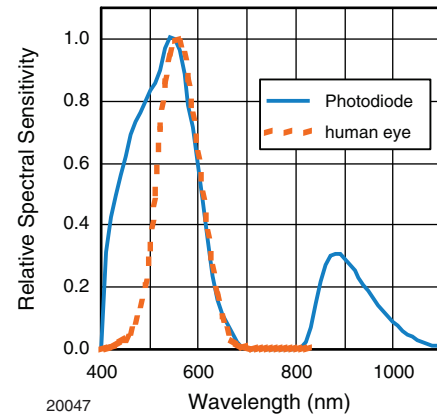


Fig. 3 - Relative Spectral Sensitivity vs. Wavelength

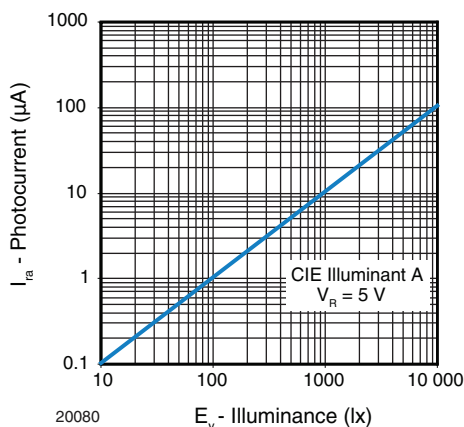


Fig. 2 - Reverse Light Current vs. Irradiance

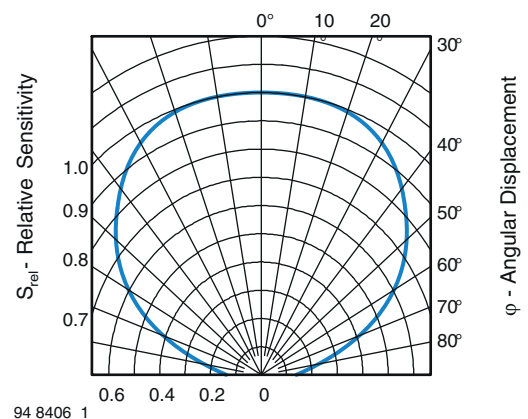
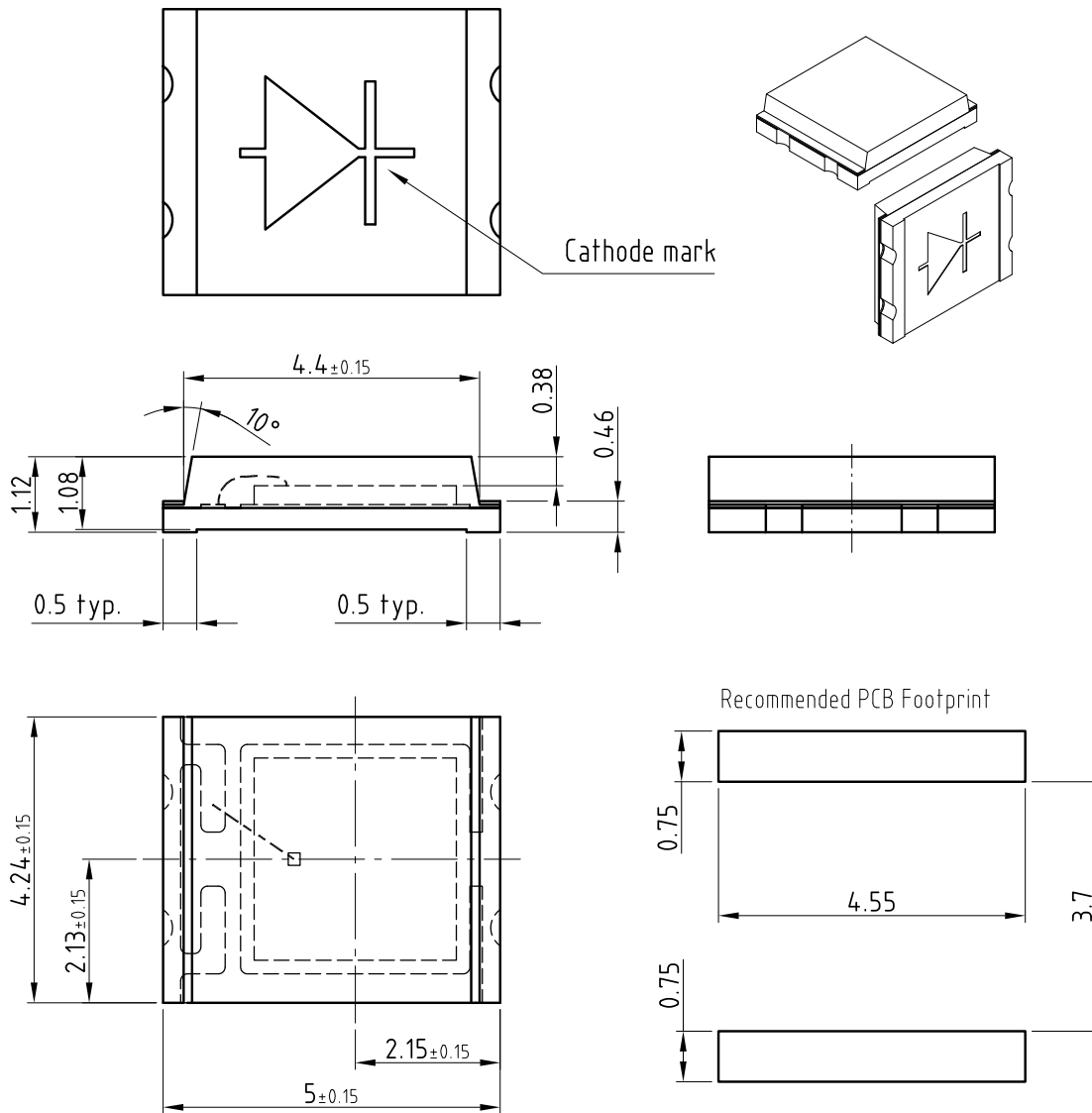


Fig. 4 - Relative Radiant Sensitivity vs. Angular Displacement

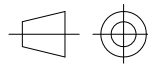


### PACKAGE DIMENSIONS in millimeters



Cathode mark

Recommended PCB Footprint

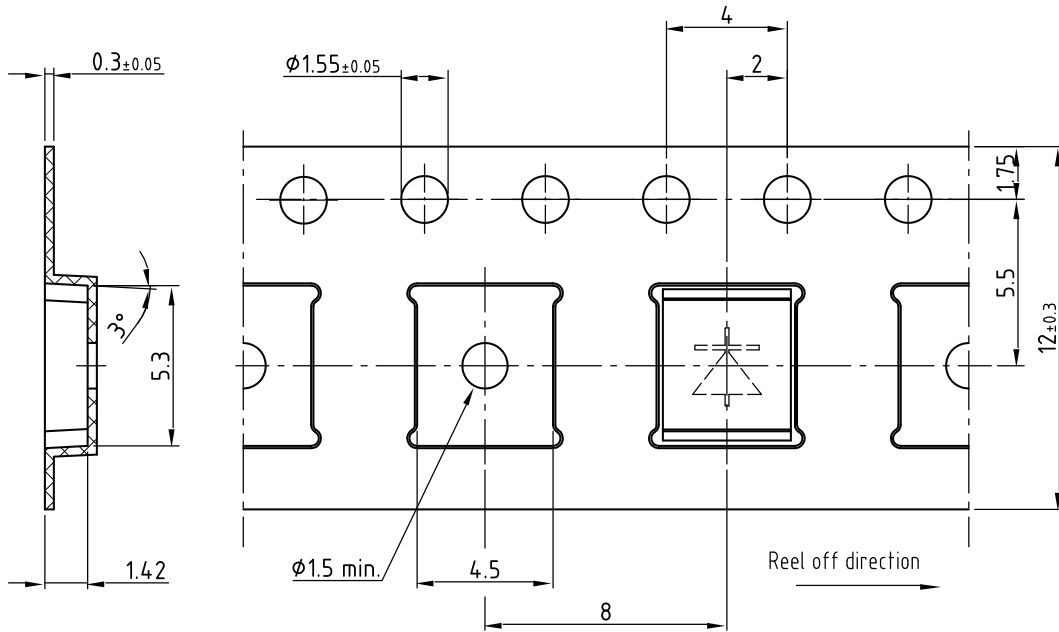


technical drawings according to DIN specifications

Drawing-No.: 6.541-5060.01-4  
Issue: 3; 05.02.08  
20536

Not indicated tolerances  $\pm 0.1$

**TAPING DIMENSIONS** in millimeters

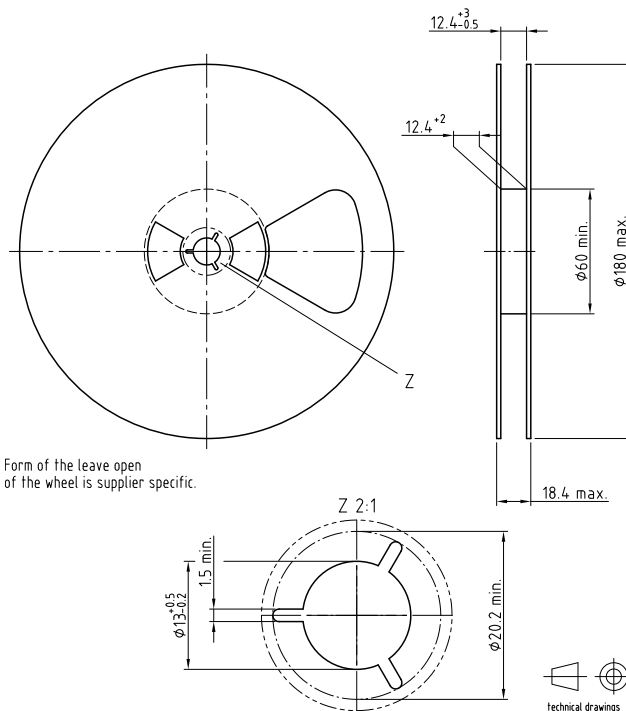


Drawing-No.: 9.700-5293.01-4  
 Issue: 1; 03.12.04  
 20537

Not indicated tolerances  $\pm 0.1$

technical drawings according to DIN specifications

**REEL DIMENSIONS** in millimeters



Form of the leave open of the wheel is supplier specific.

Drawing-No.: 9.800-5097.01-4  
 Issue: 1; 05.05.08  
 20874

technical drawings according to DIN specifications

**SOLDER PROFILE**

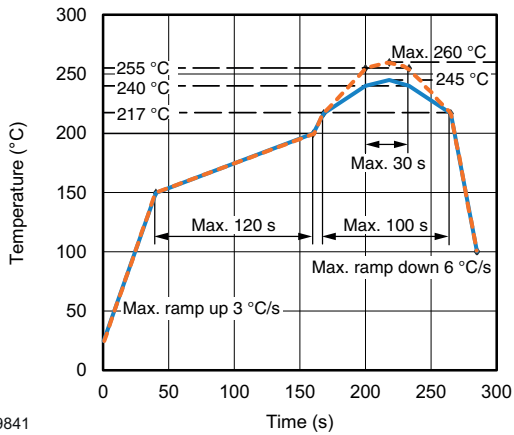


Fig. 5 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020D

**DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

**FLOOR LIFE**

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions:  $T_{amb} < 30\text{ °C}$ ,  $RH < 60\%$

**DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or recommended conditions:

192 h at 40 °C (+ 5 °C),  $RH < 5\%$

or

96 h at 60 °C (+ 5 °C),  $RH < 5\%$ .

19841



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